

Form PTO-1595
(Rev. 10/02)
OMB No. 0651-0027 (exp. 6/30/2005)
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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

- 1) AHN, Sang Tae 12.17.03
- 2) CHUNG, Sung Woong
- 3) SOHN, Hyun Chul

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: December 1, 2003

2. Name and address of receiving party(ies)

Name: HYNIX SEMICONDUCTOR INC.

Internal Address: _____

Street Address: San 136-1, Ami-ri,

Bubal-eub, Ich'on, Kyoungki-do,

Republic of Korea

City: _____ State: _____ Zip: _____

Additional name(s) & address(es) attached? Yes No

22141 U.S. PTO
10/738399

121703

4. Application number(s) or patent number(s):

10738399 December 1, 2003

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Richard J. Streit

Internal Address: _____

Street Address: c/o Ladas & Parry

224 South Michigan Avenue

City: Chicago State: IL Zip: 60604

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Richard J. Streit

Name of Person Signing
Reg. 25765

Signature

December 17, 2003

Date

Total number of pages including cover sheet, attachments, and documents: 3

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

UNITED STATES OF AMERICA
ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name : Sang Tae AHN

Address : 101-605, Hyundai Electronics Employee Apt., 441-1, Sadong-ri, Daewol-myon, Ich'on, Kyongki-do, Korea

Name : Sung Woong CHUNG

Address : 105-1402, Hyundai Electronics Employee Apt., 441-1, Sadong-ri, Daewol-myon, Ich'on, Kyongki-do, Korea

Name : Hyun Chul SOHN

Address : 106-1001, Nonhyun Apt., 22 Nonhyun-dong, Kangnam-gu, Seoul, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name : Hynix Semiconductor Inc.

Address : San 136-1, Ami-ri, Bubal-eub, Ich'on, Kyongki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

METHOD FOR FABRICATING ISOLATION LAYER IN SEMICONDUCTOR DEVICE

(TITLE)

and which is found in *(check one applicable item below)*

U.S. patent application executed on even date herewith

U.S. Application Serial No. _____ filed on _____

and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.